



March 2015

# FCD3400N80Z / FCU3400N80Z

## N-Channel SuperFET<sup>®</sup> II MOSFET

800 V, 2 A, 3.4 Ω

### Features

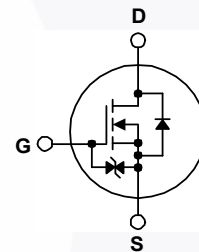
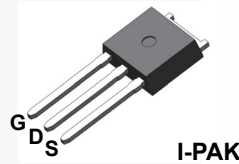
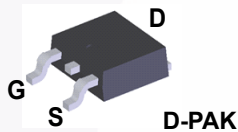
- $R_{DS(on)} = 2.75 \Omega$  (Typ.)
- Ultra Low Gate Charge (Typ.  $Q_g = 7.4$  nC)
- Low  $E_{oss}$  (Typ. 0.9 uJ @ 400V)
- Low Effective Output Capacitance (Typ.  $C_{oss(eff.)} = 41$  pF)
- 100% Avalanche Tested
- RoHS Compliant
- ESD Improved Capability

### Applications

- AC - DC Power Supply
- LED Lighting

### Description

SuperFET<sup>®</sup> II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as Audio, Laptop adapter, Lighting, ATX power and industrial power applications.



### Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	FCD3400N80Z FCU3400N80Z	Unit
$V_{DSS}$	Drain to Source Voltage	800	V
$V_{GSS}$	Gate to Source Voltage	- DC	$\pm 20$
		- AC (f > 1 Hz)	$\pm 30$
$I_D$	Drain Current	- Continuous ( $T_C = 25^\circ\text{C}$ )	2.0
		- Continuous ( $T_C = 100^\circ\text{C}$ )	1.2
$I_{DM}$	Drain Current - Pulsed (Note 1)	4.0	A
$E_{AS}$	Single Pulsed Avalanche Energy (Note 2)	12.8	mJ
$I_{AR}$	Avalanche Current (Note 1)	0.4	A
$E_{AR}$	Repetitive Avalanche Energy (Note 1)	0.32	mJ
dv/dt	MOSFET dv/dt	100	V/ns
	Peak Diode Recovery dv/dt (Note 3)	20	
$P_D$	Power Dissipation ( $T_C = 25^\circ\text{C}$ )		32
		- Derate Above $25^\circ\text{C}$	0.26
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +150	$^\circ\text{C}$
$T_L$	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds	300	$^\circ\text{C}$

### Thermal Characteristics

Symbol	Parameter	FCD3400N80Z FCU3400N80Z	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	3.9	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	

FCD3400N80Z / FCU3400N80Z — N-Channel SuperFET<sup>®</sup> II MOSFET

## Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FCD3400N80Z	FCD340080Z	DPAK	Tape and Reel	330 mm	16 mm	2500 units
FCU3400N80Z	FCU340080Z	IPAK	Tube	N/A	N/A	75 units

## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
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### Off Characteristics

$BV_{DSS}$	Drain to Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 1\text{ mA}, T_J = 25^\circ\text{C}$	800	-	-	V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 1\text{ mA}$ , Referenced to $25^\circ\text{C}$	-	0.9	-	V/ $^\circ\text{C}$
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 800\text{ V}, V_{GS} = 0\text{ V}$	-	-	25	$\mu\text{A}$
		$V_{DS} = 640\text{ V}, V_{GS} = 0\text{ V}, T_C = 125^\circ\text{C}$	-	-	250	
$I_{GSS}$	Gate to Body Leakage Current	$V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$	-	-	$\pm 10$	$\mu\text{A}$

### On Characteristics

$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 0.2\text{ mA}$	2.5	-	4.5	V
$R_{DS(on)}$	Static Drain to Source On Resistance	$V_{GS} = 10\text{ V}, I_D = 1\text{ A}$	-	2.75	3.4	$\Omega$
$g_{FS}$	Forward Transconductance	$V_{DS} = 20\text{ V}, I_D = 1\text{ A}$	-	2	-	S

### Dynamic Characteristics

$C_{iss}$	Input Capacitance	$V_{DS} = 100\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	-	299	400	pF
$C_{oss}$	Output Capacitance		-	12.7	15	pF
$C_{rss}$	Reverse Transfer Capacitance		-	0.36	-	pF
$C_{oss}$	Output Capacitance	$V_{DS} = 480\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	-	6.2	-	pF
$C_{oss(eff.)}$	Effective Output Capacitance	$V_{DS} = 0\text{ V to } 480\text{ V}, V_{GS} = 0\text{ V}$	-	41	-	pF
$Q_{g(tot)}$	Total Gate Charge at 10V	$V_{DS} = 640\text{ V}, I_D = 2\text{ A}, V_{GS} = 10\text{ V}$ (Note 4)	-	7.4	9.6	nC
$Q_{gs}$	Gate to Source Gate Charge		-	1.6	-	nC
$Q_{gd}$	Gate to Drain "Miller" Charge		-	3.1	-	nC
ESR	Equivalent Series Resistance	$f = 1\text{ MHz}$	-	3.2	-	$\Omega$

### Switching Characteristics

$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 400\text{ V}, I_D = 2\text{ A}, V_{GS} = 10\text{ V}, R_g = 4.7\ \Omega$ (Note 4)	-	10	30	ns
$t_r$	Turn-On Rise Time		-	6.4	23	ns
$t_{d(off)}$	Turn-Off Delay Time		-	22.7	55	ns
$t_f$	Turn-Off Fall Time		-	14	38	ns

### Drain-Source Diode Characteristics

$I_S$	Maximum Continuous Drain to Source Diode Forward Current	-	-	1.6	A	
$I_{SM}$	Maximum Pulsed Drain to Source Diode Forward Current	-	-	3.8	A	
$V_{SD}$	Drain to Source Diode Forward Voltage	$V_{GS} = 0\text{ V}, I_{SD} = 2\text{ A}$	-	-	1.2	V
$t_{rr}$	Reverse Recovery Time	$V_{GS} = 0\text{ V}, I_{SD} = 2\text{ A}, di/dt = 100\text{ A}/\mu\text{s}$	-	119	-	ns
$Q_{rr}$	Reverse Recovery Charge		-	868	-	nC

#### Notes:

1. Repetitive rating: pulse width limited by maximum junction temperature.
2.  $I_{AS} = 0.4\text{ A}, R_G = 25\ \Omega$ , starting  $T_J = 25^\circ\text{C}$
3.  $I_{SD} \leq 2\text{ A}, di/dt \leq 200\text{ A}/\mu\text{s}, V_{DD} \leq BV_{DSS}$ , starting  $T_J = 25^\circ\text{C}$
4. Essentially independent of operating temperature typical characteristic.

## Typical Performance Characteristics

Figure 1. On-Region Characteristics

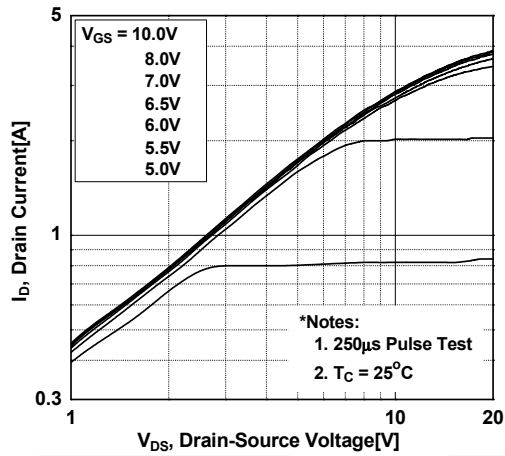


Figure 2. Transfer Characteristics

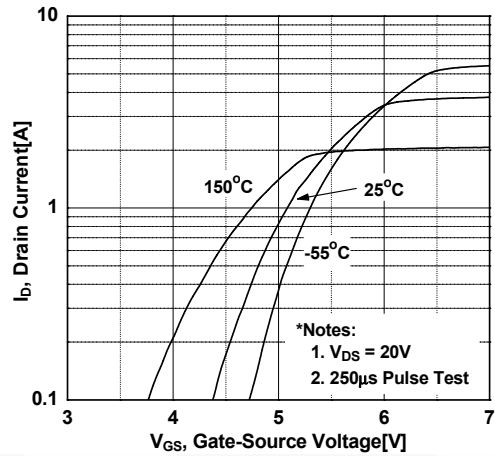


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

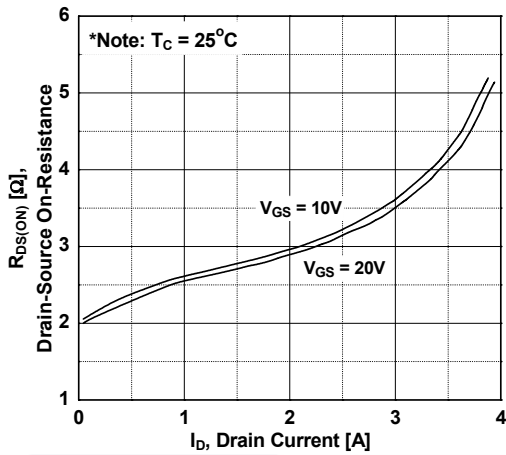


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

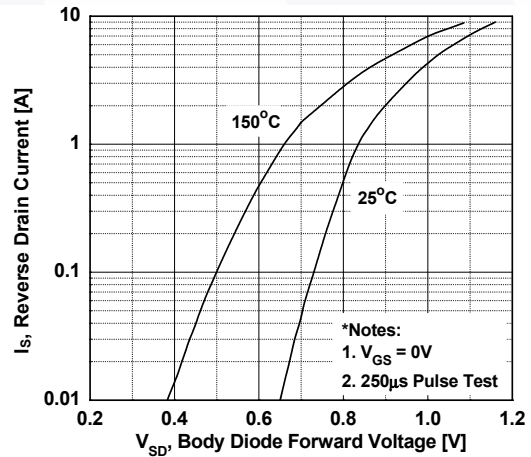


Figure 5. Capacitance Characteristics

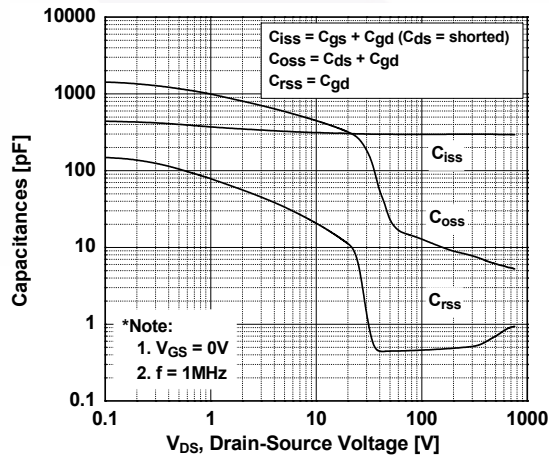
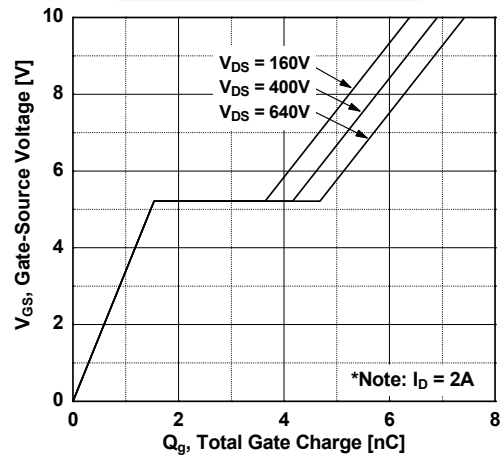
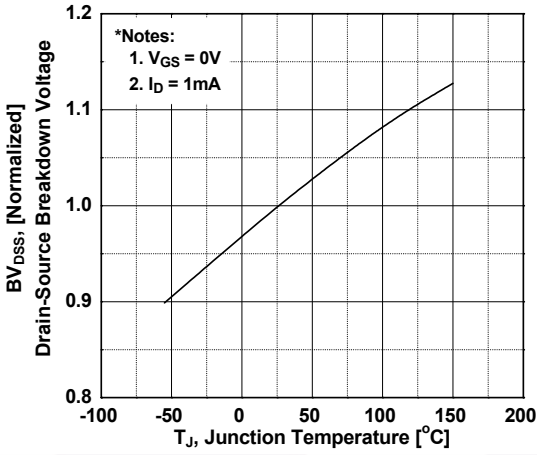


Figure 6. Gate Charge Characteristics

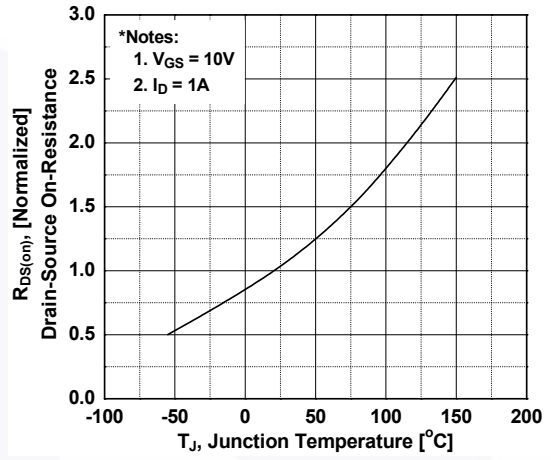


**Typical Performance Characteristics** (Continued)

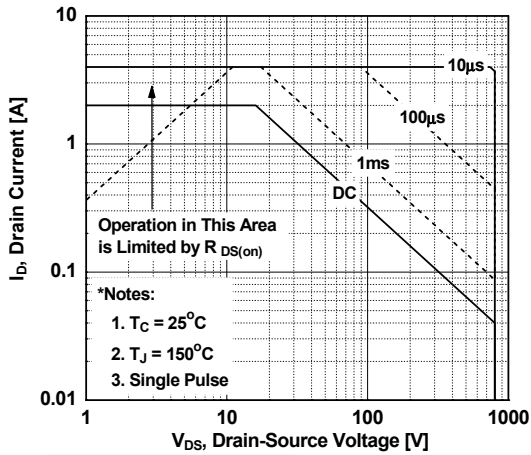
**Figure 7. Breakdown Voltage Variation vs. Temperature**



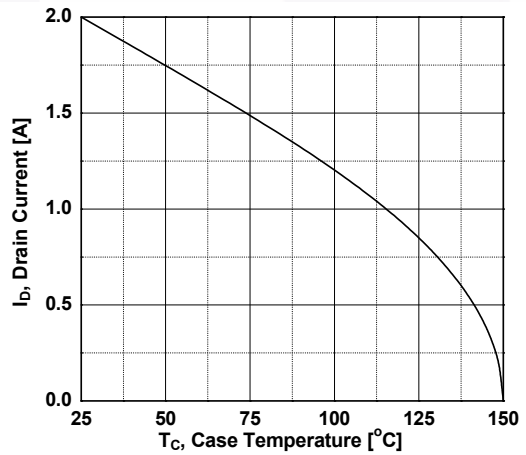
**Figure 8. On-Resistance Variation vs. Temperature**



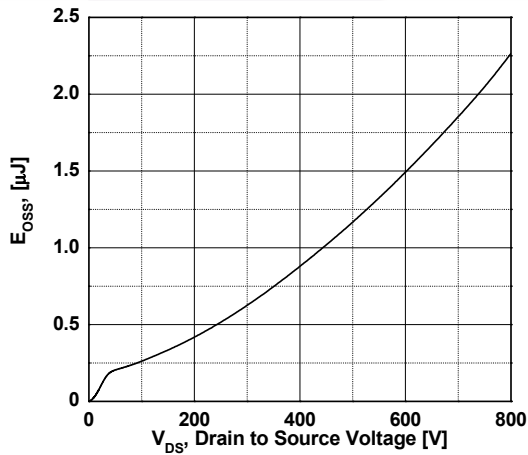
**Figure 9. Maximum Safe Operating Area**



**Figure 10. Maximum Drain Current vs. Case Temperature**

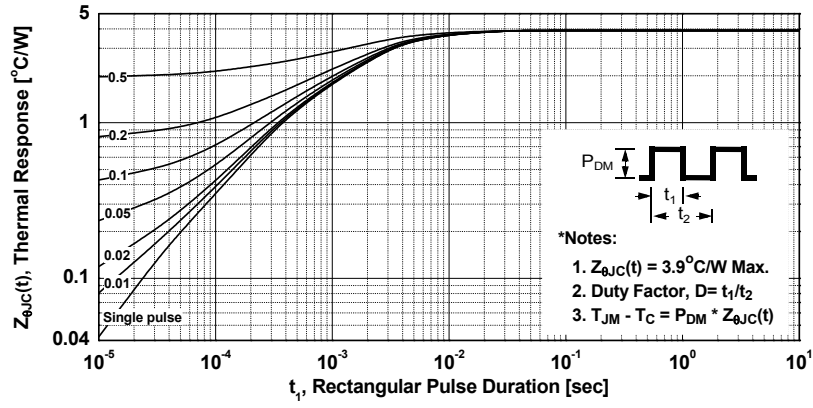


**Figure 11. E<sub>oss</sub> vs. Drain to Source Voltage**



Typical Performance Characteristics (Continued)

Figure 12. Transient Thermal Response Curve



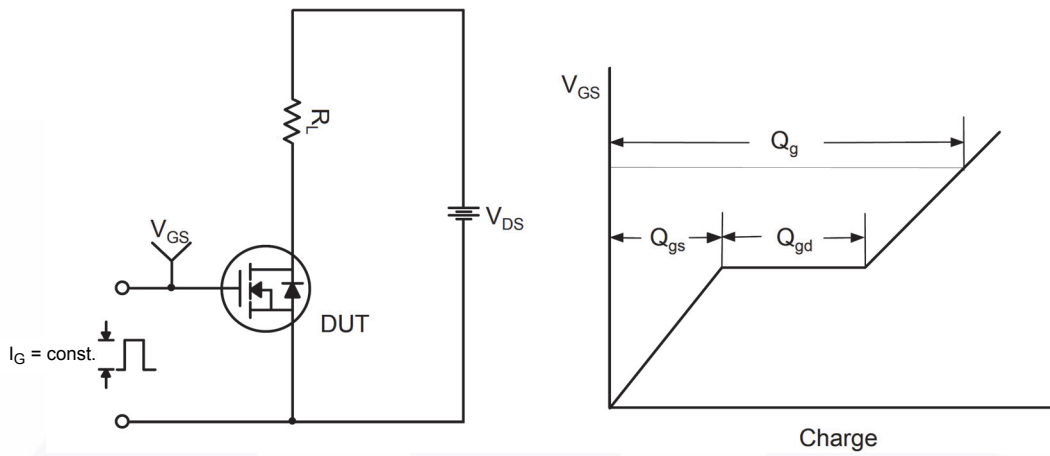


Fig 13. Gate Charge Test Circuit & Waveform

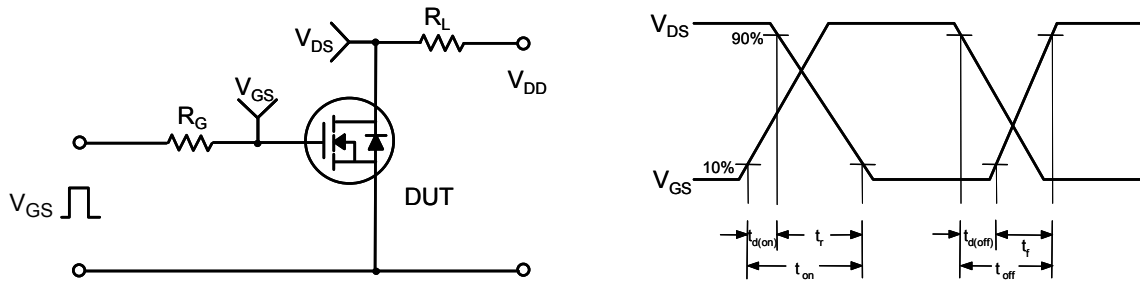


Fig 14. Resistive Switching Test Circuit & Waveforms

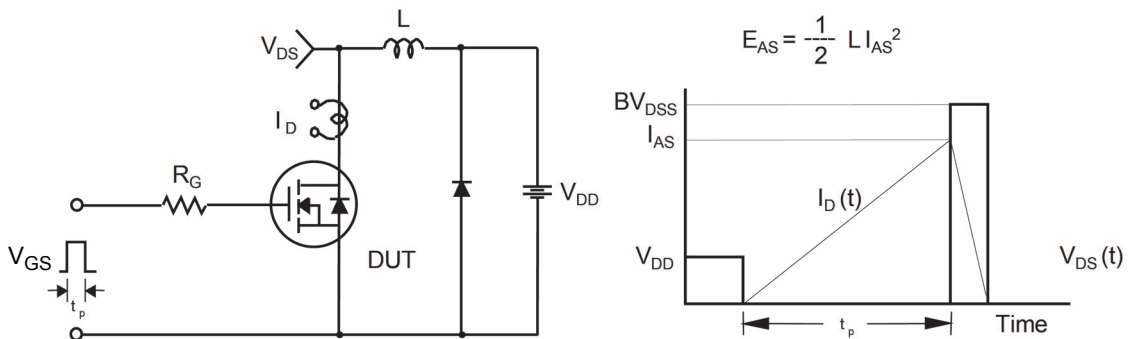


Fig 15. Unclamped Inductive Switching Test Circuit & Waveforms

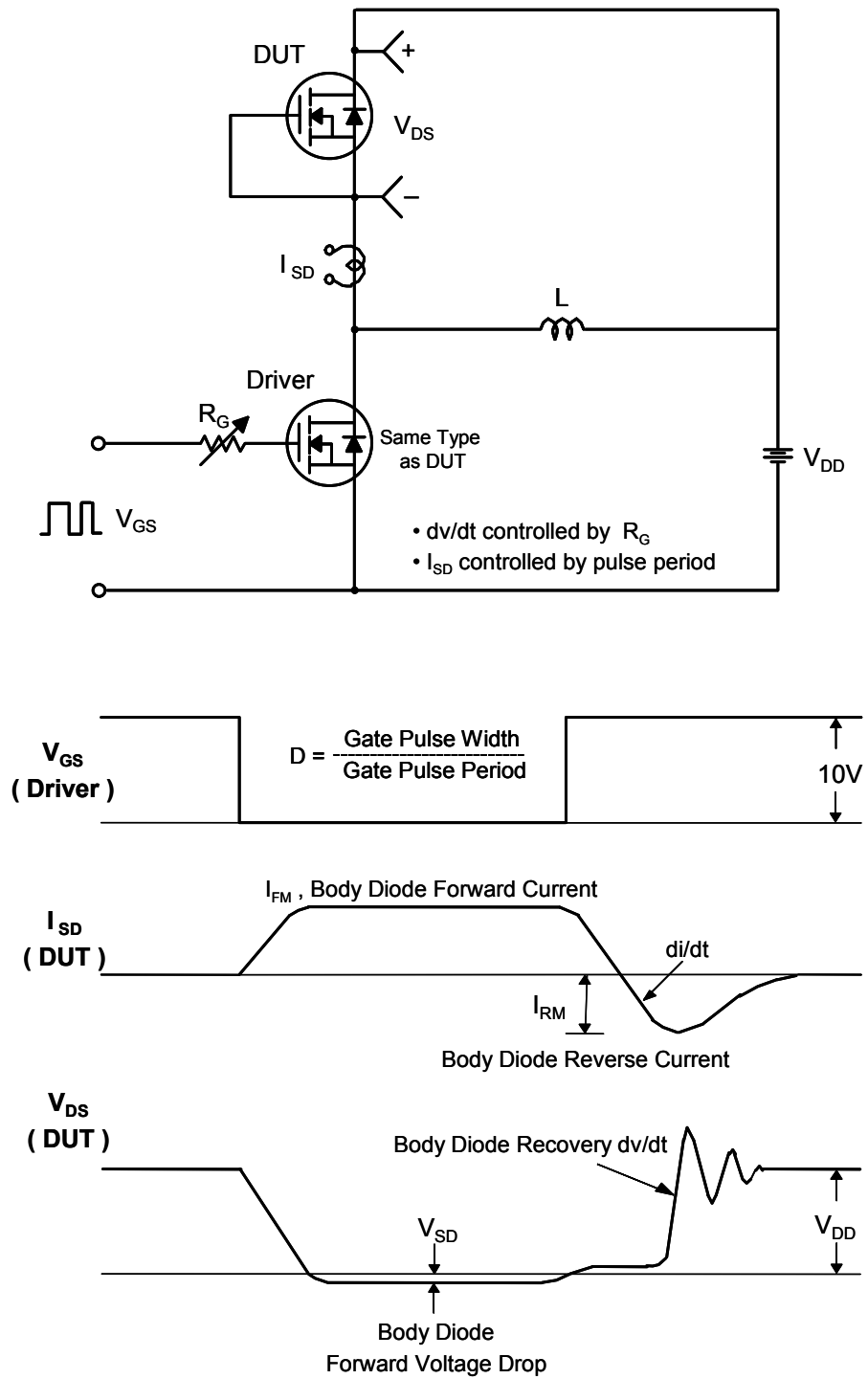
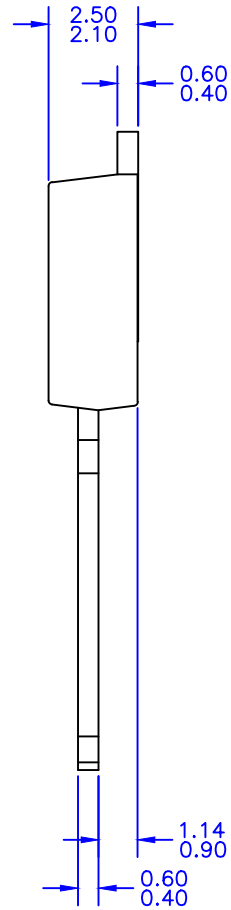
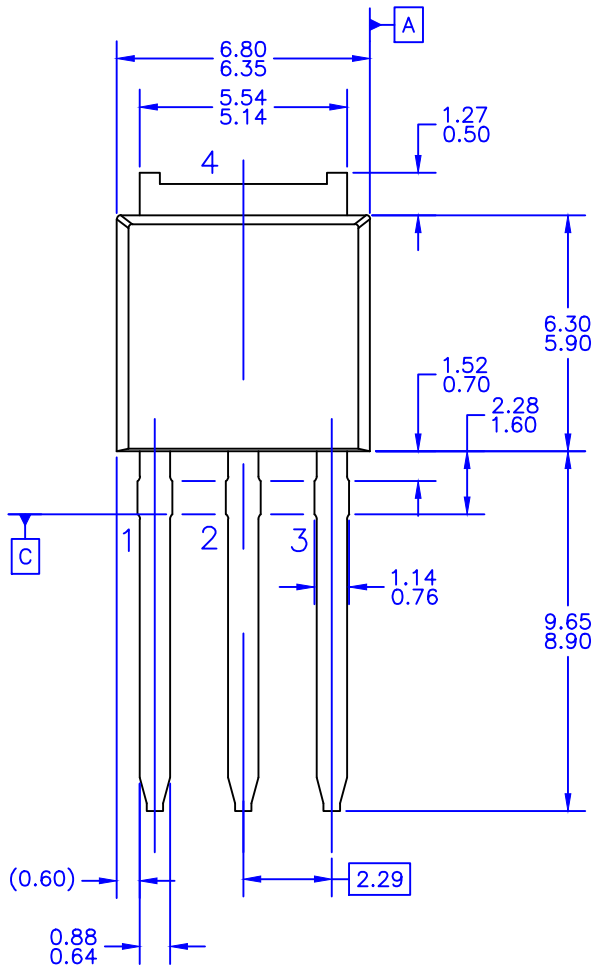
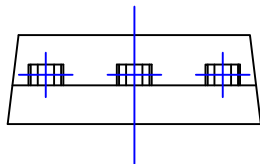


Fig 16. Peak Diode Recovery  $dv/dt$  Test Circuit & Waveforms



$\varnothing$  0.25 (M) A (M) C  
 3 PLCS

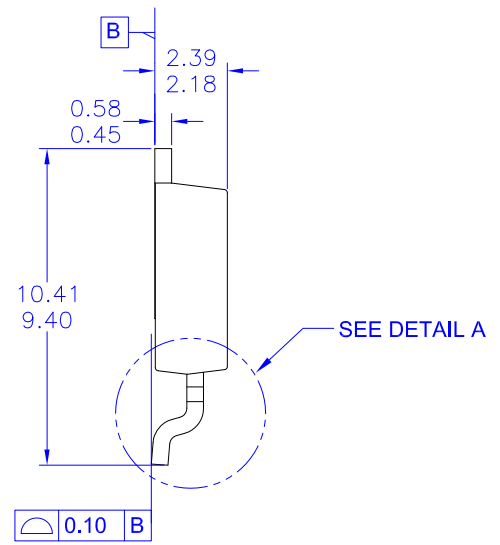
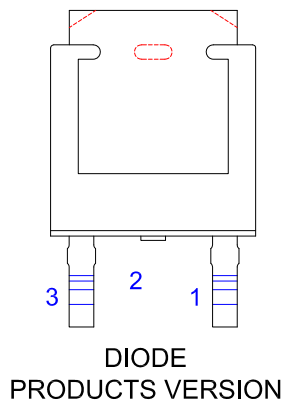
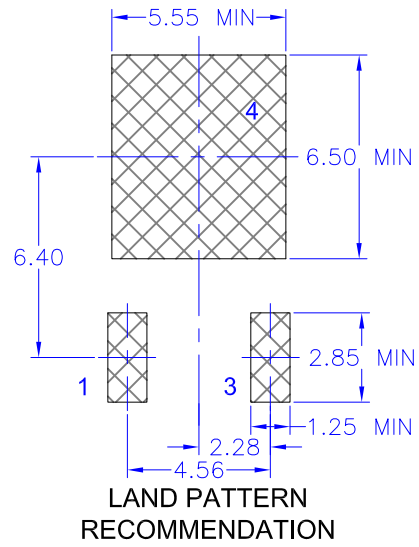


NOTES: UNLESS OTHERWISE SPECIFIED

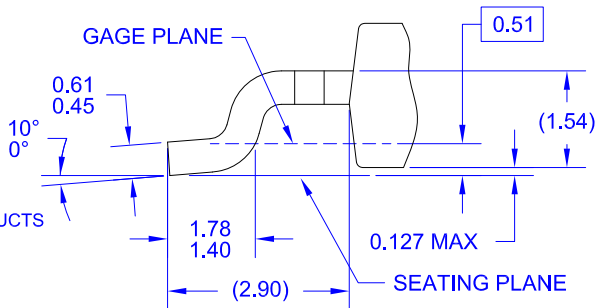
- A) ALL DIMENSIONS ARE IN MILLIMETERS.
- B) THIS PACKAGE CONFORMS TO JEDEC, TO-251, ISSUE C, VARIATION AA, DATED SEP 1988.
- C) DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- D) DRAWING NUMBER AND REVISION: MKT-T0251A03REV2







- NOTES: UNLESS OTHERWISE SPECIFIED
- A) THIS PACKAGE CONFORMS TO JEDEC, TO-252, ISSUE C, VARIATION AA.
  - B) ALL DIMENSIONS ARE IN MILLIMETERS.
  - C) DIMENSIONING AND TOLERANCING PER ASME Y14.5M-2009.
  - D) SUPPLIER DEPENDENT MOLD LOCKING HOLES OR CHAMFERED CORNERS OR EDGE PROTRUSION.
  - E) TRIMMED METAL CENTER LEAD IS PRESENT ON FOR NON-DIODE PRODUCTS
  - F) DIMENSIONS ARE EXCLUSIVE OF BURS, MOLD FLASH AND TIE BAR EXTRUSIONS.
  - G) LAND PATTERN RECOMMENDATION IS BASED ON IPC7351A STD TO228P991X239-3N.
  - H) DRAWING NUMBER AND REVISION: MKT-TO252A03REV11








**DETAIL A**  
(ROTATED -90°)  
SCALE: 12X





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| AttitudeEngine™                                                                   | FRFET®                                         |  | TinyBoost®                                                                          |
| Awinda®                                                                           | Global Power Resource <sup>SM</sup>            | Power Supply WebDesigner™                                                         | TinyBuck®                                                                           |
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| BitSiC™                                                                           | Green FPS™                                     | PowerXS™                                                                          | TinyLogic®                                                                          |
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| CorePLUS™                                                                         | Gmax™                                          | QFET®                                                                             | TinyPower™                                                                          |
| CorePOWER™                                                                        | GTO™                                           | QS™                                                                               | TinyPWM™                                                                            |
| CROSSVOL™                                                                         | IntelliMAX™                                    | Quiet Series™                                                                     | TinyWire™                                                                           |
| CTL™                                                                              | ISOPLANAR™                                     | RapidConfigure™                                                                   | TranSiC™                                                                            |
| Current Transfer Logic™                                                           | Making Small Speakers Sound Louder and Better™ |  | TriFault Detect™                                                                    |
| DEUXPEED®                                                                         | MegaBuck™                                      | Saving our world, 1mW/W/kW at a time™                                             | TRUECURRENT®*                                                                       |
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| EfficientMax™                                                                     | MicroPak™                                      | SMART START™                                                                      | UHC®                                                                                |
| ESBC™                                                                             | MicroPak2™                                     | Solutions for Your Success™                                                       | Ultra FRFET™                                                                        |
|  | MillerDrive™                                   | SPM®                                                                              | UniFET™                                                                             |
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| FACT®                                                                             | MTx®                                           | SuperSOT™-6                                                                       | XS™                                                                                 |
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| FPS™                                                                              | OptoHiT™                                       | SyncFET™                                                                          |                                                                                     |
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Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
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Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

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